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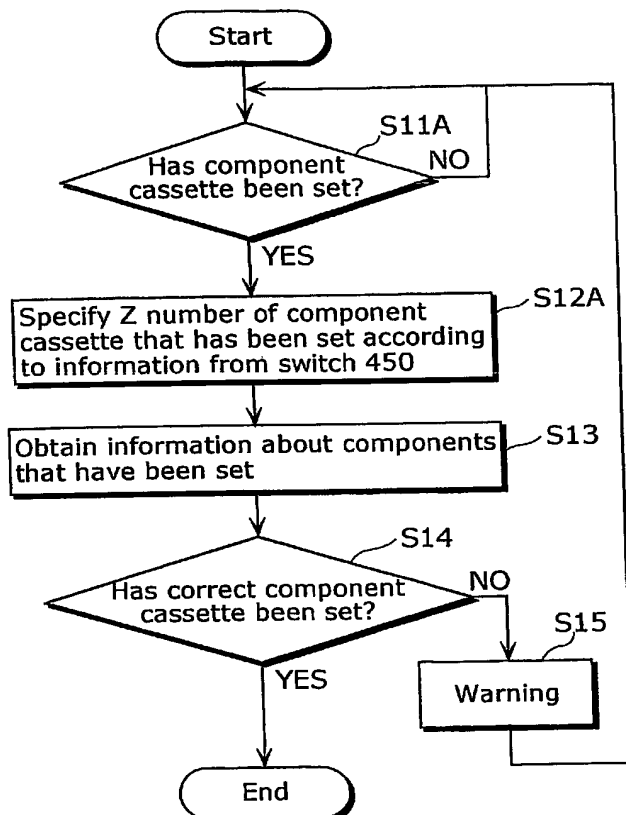
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(54) Title: COMPONENT VERIFICATION METHOD



(57) Abstract: A component verification method for a mounter (100) that is capable of performing component verification with less labor, is comprised of: a position specification step (S12A) of specifying a placement position in the mounter (100) where a component tape is placed; a read step (S13) of reading component information from an IC tag (426b) that is attached to the component tape or a reel (426); and a verification step (S14) of verifying the component information and the placement position against component arrangement data that indicates components that should be mounted onto the board as well a position where the component tape should be placed.

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